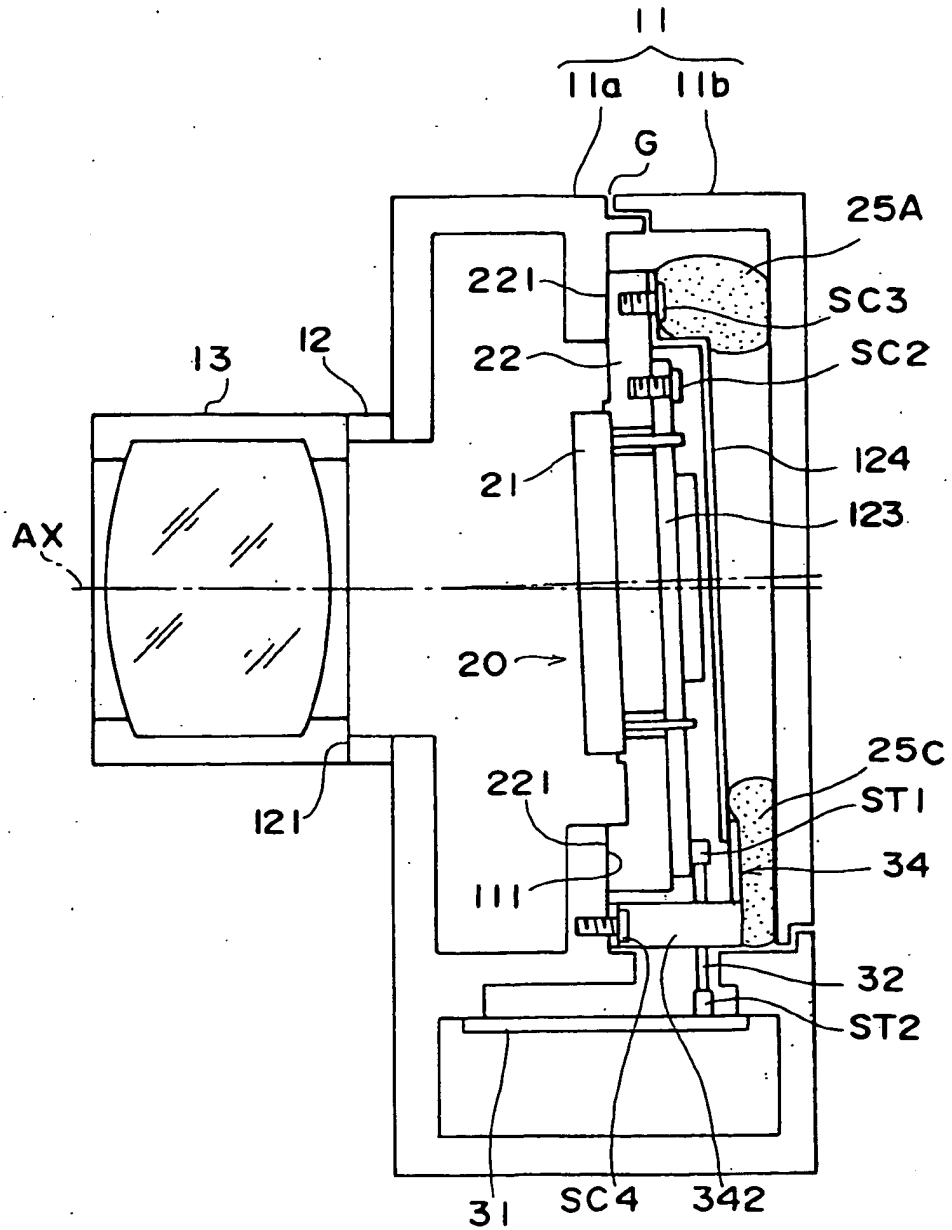


FIG. 4



Approved
for 2/5/05

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